

RoHS

COMPLIANT HALOGEN

FREE Available

Vishay Siliconix

P-Channel 200 V (D-S) MOSFET

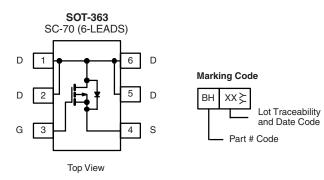
PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)		
- 200	5.0 at V _{GS} = - 10 V	- 0.38	4.1		
	5.1 at V _{GS} = - 6 V	- 0.37	4.1		

FEATURES

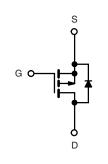
- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFETS
- Small, Thermally Enhanced SC-70 Package
- Ultra Low On-Resistance
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

• Active Clamp Circuits in dc-to-dc Power Supplies



Ordering Information: Si1419DH-T1-E3 (Lead (Pb)-free) Si1419DH-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25 \degree C$, unless otherwise noted						
Parameter		Symbol	5 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	- 200		V	
Gate-Source Voltage		V _{GS}	± 20			
Continuous Drain Current (T 150 °C)a	T _A = 25 °C	- I _D	- 0.38	- 0.3		
Continuous Drain Current $(T_J = 150 \ ^{\circ}C)^a$	T _A = 85 °C		- 0.27	- 0.22		
Pulsed Drain Current		I _{DM}	- 0.5		А	
Continuous Diode Current (Diode Conduction) ^a		۱ _S	- 1.3	- 0.83		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	- 1.9			
Single Pulse Avalanche Energy	L = 0.1 mm	E _{AS}	0.18		mJ	
Maximum Power Dissipation ^a	T _A = 25 °C	P	1.56	1.0	W	
Maximum rower Dissipation	T _A = 85 °C	P _D	0.81	0.52	vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	t ≤ 5 s	R _{thJA}	60	80	°C/W
Maximum Junction-to-Amblent	Steady State		100	125	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	34	45	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

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SPECIFICATIONS T _J = 25 °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static								
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -100 \ \mu A$	- 2.5		- 4.5	V		
Gate-Body Leakage	I_{GSS} $V_{DS} = 0 V, V_{GS} = \pm 20 V$				± 100	nA		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -200 \text{ V}, V_{GS} = 0 \text{ V}$			- 1			
		$V_{DS} = -200 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$				μΑ		
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 15 V, V _{GS} = - 10 V	- 0.5			А		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 0.4 A		3.98	5.0	Ω		
		$V_{GS} = -6 V, I_{D} = -0.4 A$		4.06	5.1	52		
Forward Transconductance ^a	Forward Transconductance ^a g_{fs} $V_{DS} = -10 \text{ V}, I_D =$			1.0		S		
Diode Forward Voltage ^a	V_{SD}	I _S = - 0.4 A, V _{GS} = 0 V		- 0.80	- 1.1	V		
Dynamic ^b								
Total Gate Charge	Qg			4.1	6.2	nC		
Gate-Source Charge	Q _{gs}	V_{DS} = - 100 V, V_{GS} = - 10 V, I_{D} = - 0.4 A		0.8				
Gate-Drain Charge	Q _{gd}			1.3				
Gate Resistance R		f = 1.0 MHz		17		Ω		
Turn-On Delay Time	t _{d(on)}			6	9	ns		
Rise Time	t _r	V_{DD} = - 100 V, R_L = 100 Ω		12	18			
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 1 A, V_GEN = - 4.5 V, R_g = 6 Ω		12	18			
Fall Time	t _f			12	18			
Reverse Recovery Time	t _{rr}	I _F = - 0.4 A, dl/dt = 100 A/μs		55	83			
Body Diode Reverse Recovery Charge	Q _{rr}	$r_{\rm F} = -0.4$ A, $a/at = 100$ A/ μ s		130	200	nC		

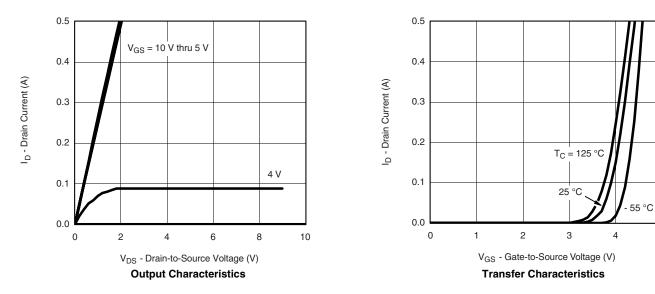
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



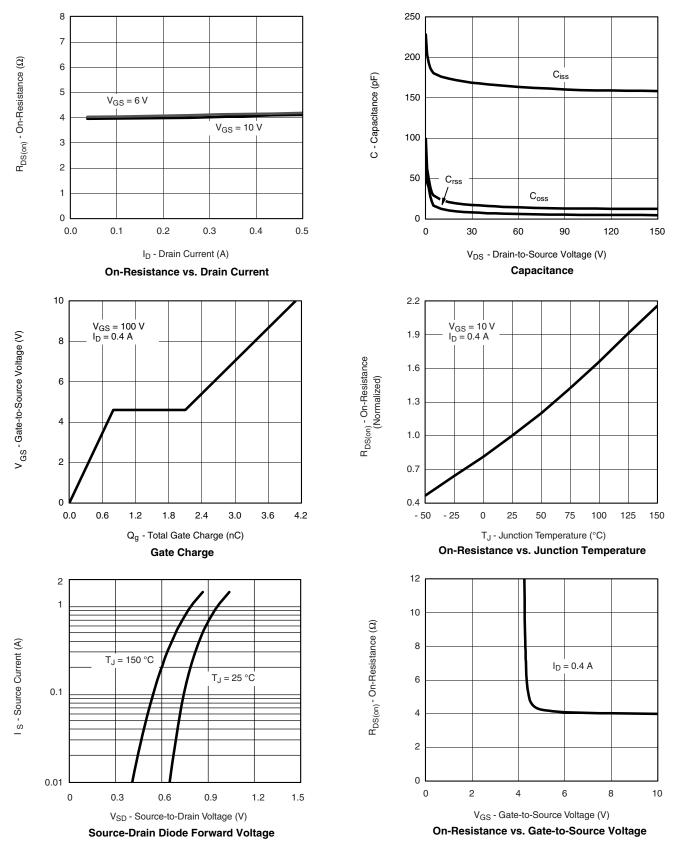
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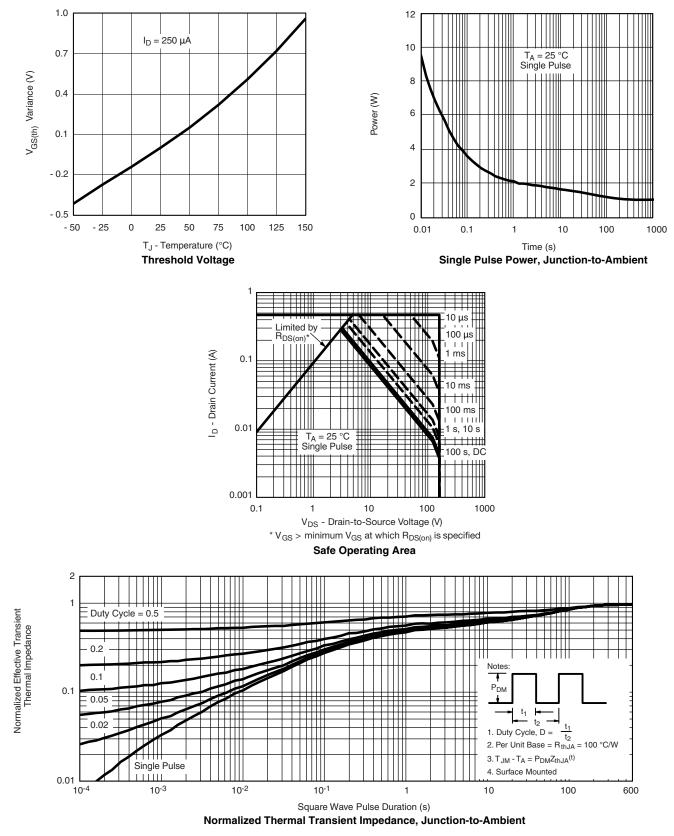
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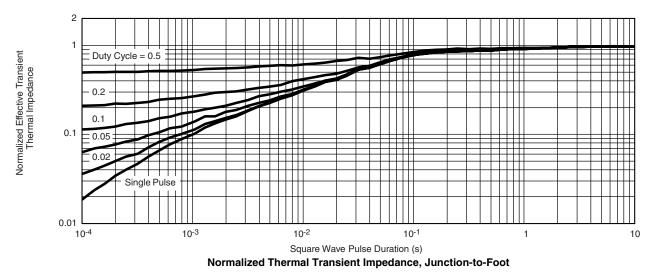


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Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?73241.



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